4/29105	05-03-2005	FLH Ref. No.: 450100-0541
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To the Honorable Commissioner	102993425	ched original documents or copy thereof.
1. Name of conveying parties  Ryoko AMANO, Koichi SATO, Makoto TABUCH Hajirne YOSHIMASU, Kaori KASHIMOTO, Koji Hiroyuki MASUDA, Kayoko YAMASAKI, Ryuji TAdditional name(s) of conveying party(ies) attached? Yes X_ No  3. Nature of conveyance:  X Assignment Security Agreement Merger Change of Name	II, Susumu IJICHI, KOBAYASHI, TAKENOUCHI SONY C 7-35 Kit Shinaga	nd address of receiving party(ies)  CORPORATION tashinagawa 6-chome wa-Ku, Tokyo 141-0001, Japan  nal name(s) & address(es) attached? YesX No
Other Execution Date(s): March 15, March 28, March 25, 28, March 23, March 29, March 23, March 16 and A  4. Application number(s) or patent number(s):  If this document is being filed together with a new a A. Patent Application No. 11/032,997 filed January Additional numbers attached? YesX_ No	April 1, 2005 application, the execution date of t	OPR/FINANCE the application is:
Name and address of party to whom correspondence document should be mailed:	e concerning 6. Total nu	amber of applications and patents involved 1
Name: WILLIAM S. FROMMER Internal Address: FROMMER LAWRENCE & H Street Address: 745 FIFTH AVENUE City: NEW YORK State: NY Zip	X Encl   Auth 	te (37 CFR 3.41) \$ 40.00 losed norized to be charged to deposit account 50-0320 account number: duplicate copy of this page if paying by deposit account)
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9. Statement and signature.  To the best of my knowledge and belief, the foregoing th	ing information is true and correct	and any attached copy is a true copy of the original document.  April 25, 2005
Name of Person Signing	Signature 41,	442 Date

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## ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

## INFORMATION PROCESSING APPARATUS AND METHOD, AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which rnay be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/032,997, Filing Date: January 11, 2005.

This assignment executed on the dates indicated below.

Ryoko AMANO	
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of First or sole inventor	
Ryoko Amano Signature of first or sole inventor	March 15, 2005  Date of this assignment
Signature of first or sole inventor	Date of this assignment
Koichi SATO	
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	**
Residence of second inventor	
Koichi Sato	March 28, 2005  Date of this assignment
Signature of second inventor	Date of this assignment
Makoto TABUCHI	
Name of third inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of third inventor	W A
Makoto Tabuchi	March 25, 2005
Signature of third inventor	Date of this assignment
•	

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## ADDITIONAL INVENTORS

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Name of fourth inventor	Execution date of U.S. Patent Application
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Signature of fourth inventor	March 17, 2005
Signature of fourth inventor	Date of this assignment
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Residence of fifth inventor	4 4 4 4
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Signature of fifth inventor	Date of this assignment
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Residence of sixth inventor	
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Signature of sixth inventor	Date of this assignment
Koji KOBAYASHI	
Name of seventh inventor	Execution date of U.S. Patent Application
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Koji Kobayashi Signature of seventh inventor	March 29, 2005  Date of this assignment
Signature of seventh inventor	Date of this assignment
Hiroyuki MASUDA	
Name of eighth inventor	Execution date of U.S. Patent Application
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Residence of eighth inventor	
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Signature of eighth inventor	Date of this assignment
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Name of ninth inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	Execution date of O.S. I dent Application
Residence of ninth inventor	
Cayoko Gamasalci	March. 16, 2005
Signature of ninth inventor	Date of this assignment
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Ryuji TAKENOUCHI Name of tenth inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	Execution date of O.S. Fatent Application
Residence of tenth inventor	A 1
Rynji Takenouchi	April 1, 20at
Signature of tenth inventor	Date of this assignment
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**RECORDED: 04/29/2005**